

**FOR OPTICAL DAA, HIGH LINEAR
16-PIN SOP PHOTOCOUPLER**

-NEPOC Series-

DESCRIPTION

The PS8741 is an optically coupled isolator containing a GaAs LED on the input side and two photodiodes on the output side.

It is suitable for analog control applications such as PCMCIA card, modem, voice telephony and fax machines.

FEATURES

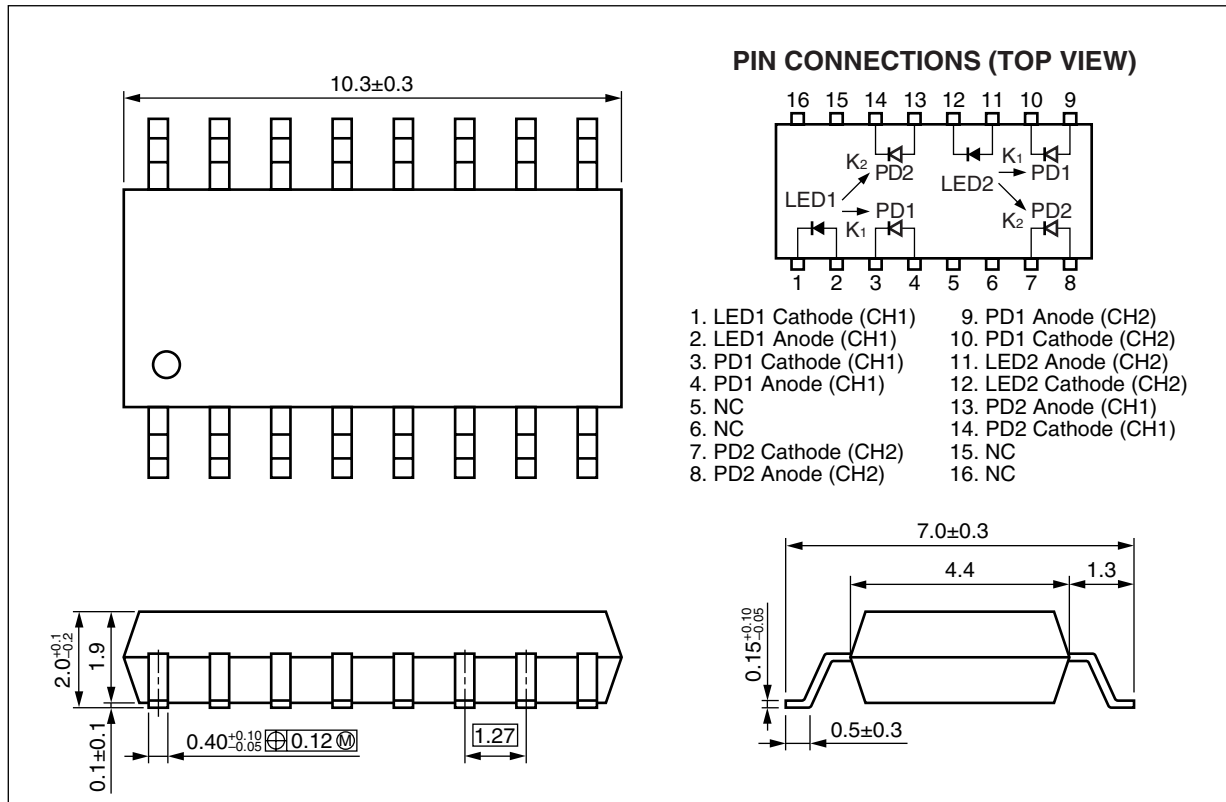
- For PCMCIA
- Small and thin package (16-pin SOP: Pin pitch = 1.27 mm, Height = 2.1 mm)
- High transfer gain linearity ($\Delta K_3 = 1\% \text{ MAX.}$)
- High isolation voltage ($BV = 1\,500 \text{ Vr.m.s.}$)
- Ordering number of taping product: PS8741-F3, F4: 2 500 pcs/reel
- <R> • Safety standards
 - UL approved: File No. E72422
 - BSI approved: No. 8525, 8526

APPLICATIONS

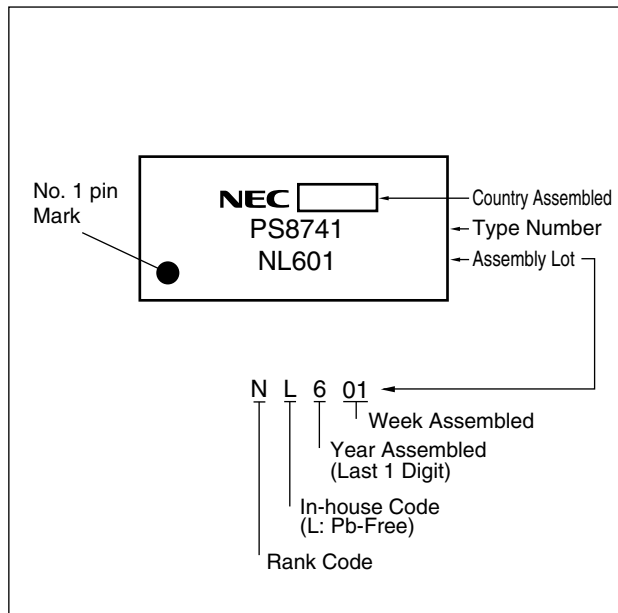
- PCMCIA card
- Notebook PC, PDA
- Modem
- Telephone, FAX

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PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE



<R> **ORDERING INFORMATION**

Part Number	Order Number	Solder plating Specification	Packing Style	Safety Standard	Application Part Number ^{*1}
PS8741	PS8741-A	Pb-Free	Magazine case 45 pcs	Standard products (UL, BSI Approved)	PS8741
PS8741-F3	PS8741-F3-A		Embossed Tape 2 500 pcs/reel		
PS8741-F4	PS8741-F4-A				

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	I _F	50	mA
	Reverse Voltage	V _R	3	V
	Power Dissipation	P _D	80	mW/ch
	Peak Forward Current ^{*1}	I _{FP}	0.5	A
Detector	Reverse Voltage	V _R	20	V
	Power Dissipation	P _C	50	mW/ch
Isolation Voltage ^{*2}		BV	1 500	Vr.m.s.
Total Power Dissipation		P _T	180	mW
Operating Ambient Temperature		T _A	-40 to +85	°C
Storage Temperature		T _{stg}	-40 to +100	°C

*1 PW = 100 μs, Duty Cycle = 1%

*2 AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output
Pins 1-8 shorted together, 9-16 shorted together.

ELECTRICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)

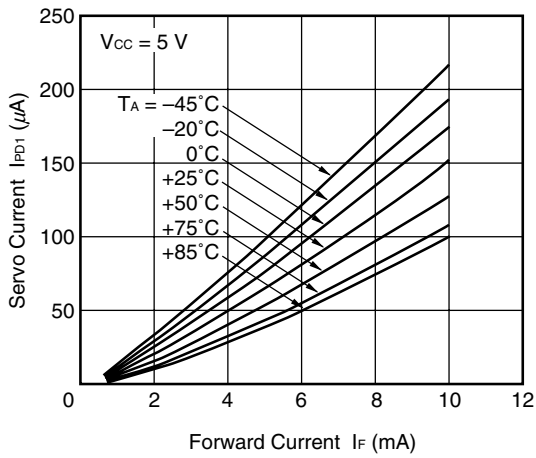
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 5 mA		1.1	1.4	V
	Reverse Current	I _R	V _R = 3 V			10	μA
	Terminal Capacitance	C _t	V = 0 V, f = 1 MHz		30		pF
Detector	Dark Current	I _D	V _{CC} = 5 V, I _F = 0 mA		1	25	nA
Coupled	Servo Gain (I _{PD1} /I _F)	K ₁	V _{CC} = 5 V, I _F = 2 mA	0.3	1.0	1.8	%
	Forward Gain (I _{PD2} /I _F)	K ₂		0.3	1.0	1.8	
	Transfer Gain (K ₂ /K ₁)	K ₃	V _{CC} = 5 V, I _F = 2 mA	0.75	1.0	1.25	
	Transfer Gain Linearity	ΔK ₃	V _{CC} = 5 V, I _F = 2 to 10 mA		0.3	1	%
	K ₃ Temperature Coefficient	ΔK ₃ /ΔT	V _{CC} = 5 V, I _F = 2 to 10 mA, T _A = -40 to +85°C		0.005		%/°C

USAGE CAUTIONS

1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. By-pass capacitor of more than 0.1 μF is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
3. Avoid storage at a high temperature and high humidity.

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

SERVO CURRENT vs. FORWARD CURRENT



SERVO GAIN vs. FORWARD CURRENT

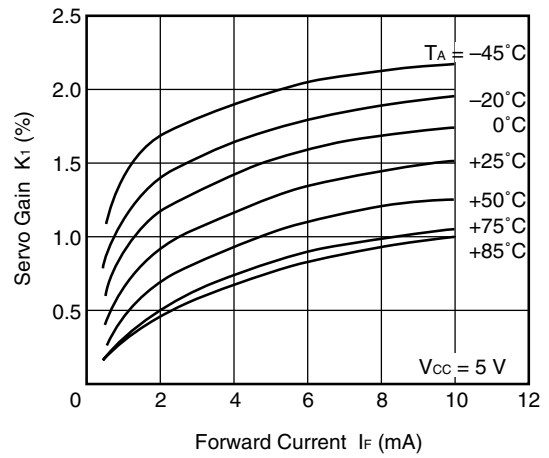
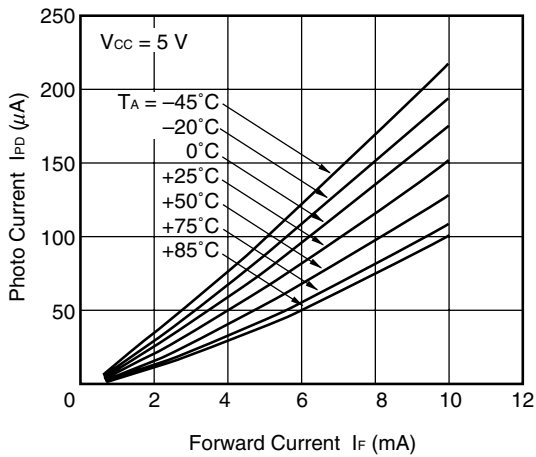
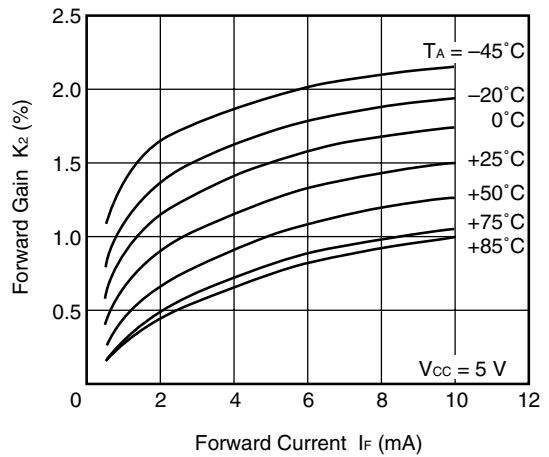


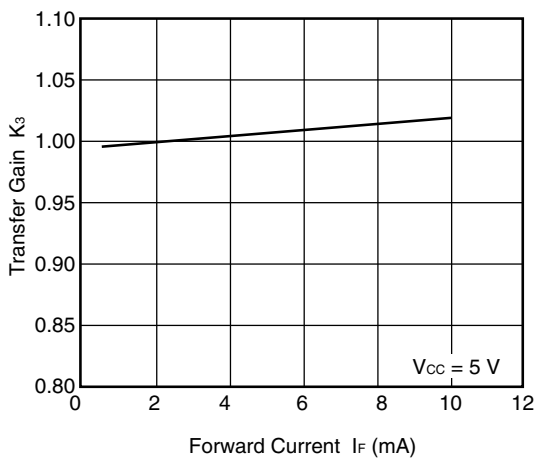
PHOTO CURRENT vs. FORWARD CURRENT



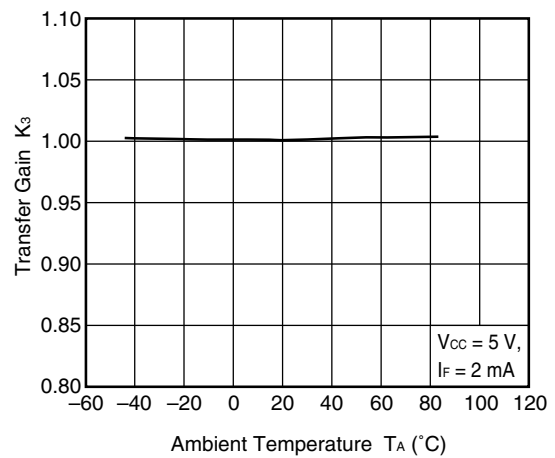
FORWARD GAIN vs. FORWARD CURRENT



TRANSFER GAIN vs. FORWARD CURRENT



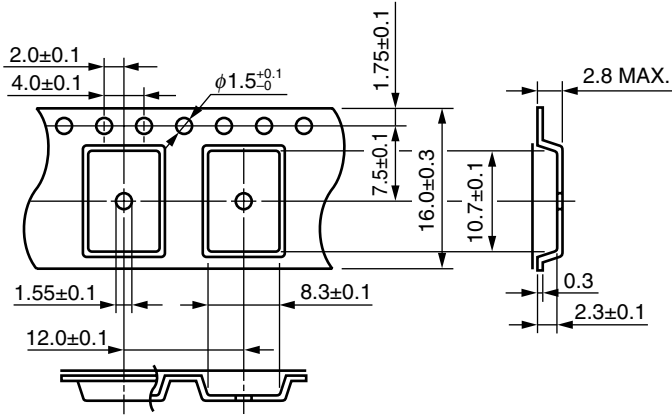
TRANSFER GAIN vs. AMBIENT TEMPERATURE



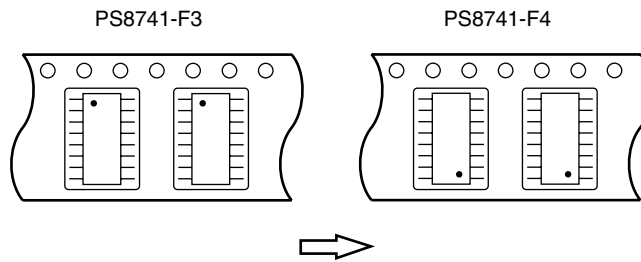
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

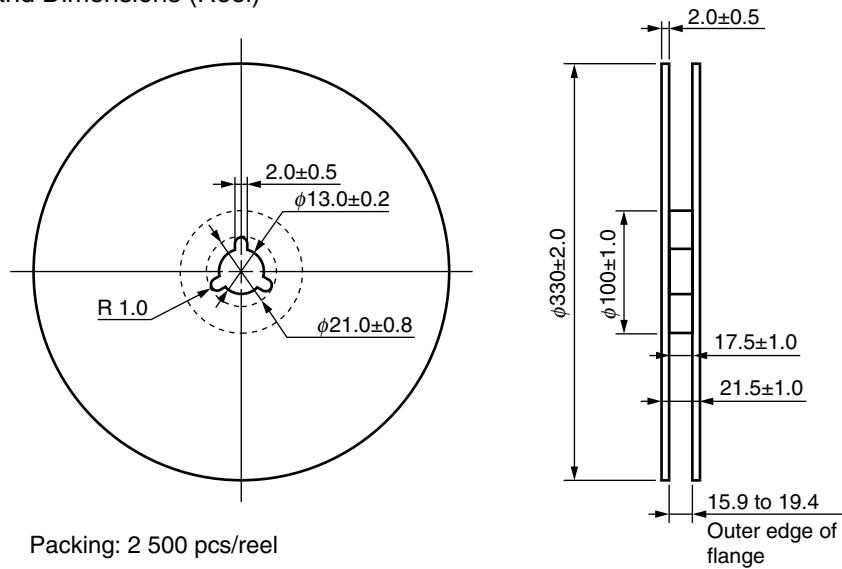
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



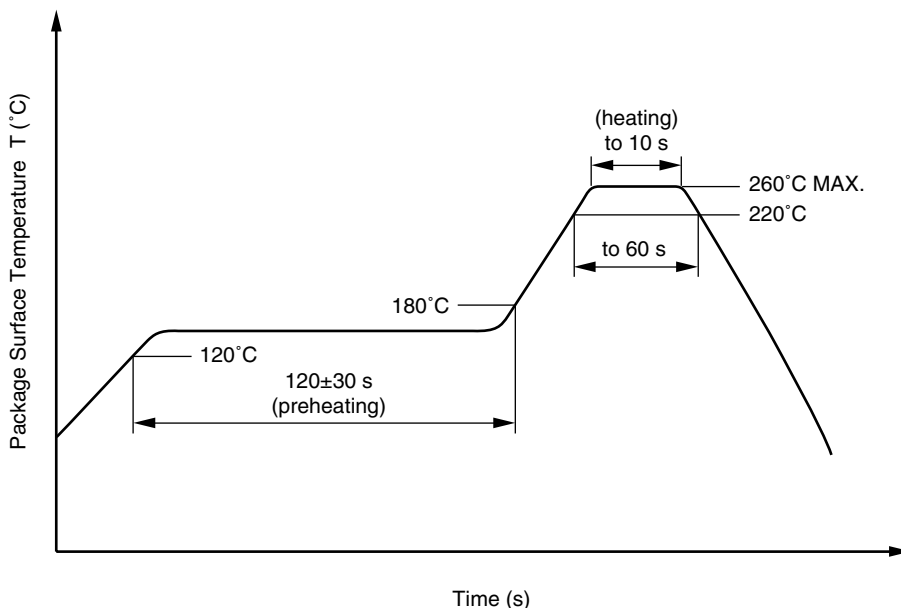
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

<R> **(3) Soldering by soldering iron**

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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(Note)

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<p>Caution</p>	<p>GaAs Products</p>	<p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"> • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. <ol style="list-style-type: none"> 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.
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► For further information, please contact

NEC Compound Semiconductor Devices Hong Kong Limited

E-mail: contact@ncsd-hk.necel.com

Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309
 Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859
 Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH <http://www.eu.necel.com/>

TEL: +49-211-6503-0 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. <http://www.cel.com/>

TEL: +1-408-988-3500 FAX: +1-408-988-0279

Compound Semiconductor Devices Division

NEC Electronics Corporation

URL: <http://www.ncsd.necel.com/>